

Microchip**Filter specification****TFS190D****1/5****Measurement condition**

Ambient temperature:	23	°C
Input power level:	0	dBm
Terminating impedance: *		
Input:	1220 Ω -6,7 pF	
Output:	510 Ω -10.2 pF	

Characteristics**Remark:**

The reference level for the relative attenuation a_{rel} of TFS190D is the minimum of the pass band attenuation a_{min} . This value is defined as the insertion loss a_e . The centre frequency f_c is the arithmetic mean value of the upper and lower frequencies at the 3 dB filter attenuation level relative to the insertion loss a_e . The given values for the relative attenuation a_{rel} and the group delay ripple have to be reached at the frequencies given below, even if the centre frequency f_c is shifted due to the temperature coefficient of frequency TC_f in the operating temperature range and due to a production tolerance for the centre frequency f_c .

D a t a		typ. Value	Limit
Insertion Loss (Reference level)	$a_e = a_{min}$	8 dB	max. 10 dB
Nominal Frequency	f_N	-	190 MHz
5 dB - Bandwidth	BW	1,6 MHz	min. 1,26 MHz
Pass Band Ripple $f_N \pm 0,300$ MHz	-	0,3 dB	max. 1,2 dB
Relative Attenuation	a_{rel}		
$f_N \pm 0,63$ MHz		-	max. 5 dB
$f_N \pm 1,25$ MHz ... $f_N \pm 20$ MHz		-	min. 35 dB
$f_N - 1,25$ MHz		45 dB	min. 35 dB
$f_N + 1,25$ MHz		45 dB	min. 35 dB
$f_N \pm 2,05$ MHz		40 dB	min. 37 dB
Group delay ripple $f_N \pm 0,630$ MHz		-	max. 1 μ s
Operating Temperature Range			- 40 °C ... + 65 °C
Storage Temperature Range			- 40 °C ... + 85 °C
Temperature coefficient of frequency TC_f^{**}		-0,036 ppm/K ²	-
Frequency inversion temperature T_0		+ 25 °C	-

*) The terminating impedances depend on parasitics and q-values of matching elements and the board used, and are to be understood as reference values only. Should there be additional questions do not hesitate to ask for an application note or contact our design team.

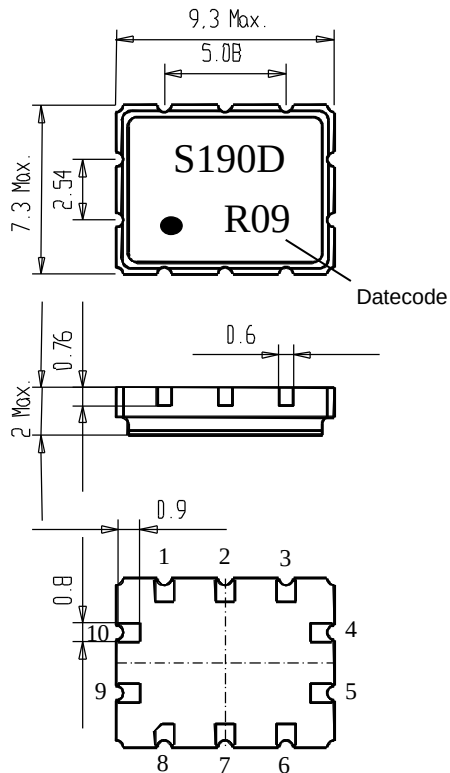
**) $\Delta f(\text{Hz}) = TC_f(\text{ppm/K}^2) \times (T - T_0)^2 \times f_{T0}(\text{MHz})$

Generated:

Checked / approved:

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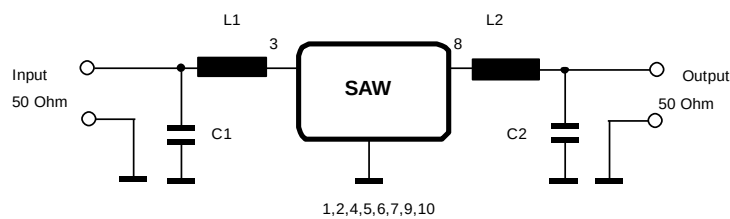
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Construction and pin connectionPinning

- | | |
|----|------------------|
| 1 | Ground |
| 2 | Input RF return |
| 3 | Input |
| 4 | Ground |
| 5 | Ground |
| 6 | Ground |
| 7 | Output RF return |
| 8 | Output |
| 9 | Ground |
| 10 | Ground |

DatecodeYear+month

N	2001
P	2002
R	2003
...	

50 Ω test circuit (unbalanced)**Microchip Frequency Technology GmbH****Potsdamer Straße 18****D 14 513 TELTOW / Germany****Tel: (+49) 3328 4784-0 / Fax: (+49) 3328 4784-30**

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Microchip**Filter specification****TFS190D****3/5****Stability characteristics**

After the following tests the filter shall meet the whole specification:

1. Shock: 500g, 18 ms, half sine wave, 3 shocks each plane;
DIN IEC 68 T2 - 27
2. Vibration: 10 Hz to 500 Hz, 0,35 mm or 5g respectively, 1 octave per min, 10 cycles per plan, 3 plans;
DIN IEC 68 T2 - 6
3. Change of temperature: -55 °C to 125°C / 30 min. each / 10 cycles
DIN IEC 68 part 2 – 14 Test N
4. Resistance to solder heat (reflow): reflow possible: twice max.;
for temperature conditions, please refer to the attached "Air reflow temperature conditions" on page 4;

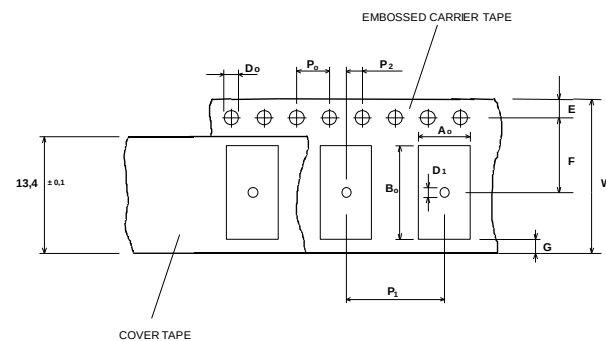
Packing

Tape & Reel: DIN IEC 286 - 3, with exception of value for N and minimum bending radius;
tape type II, embossed carrier tape with top cover tape on the upper side;

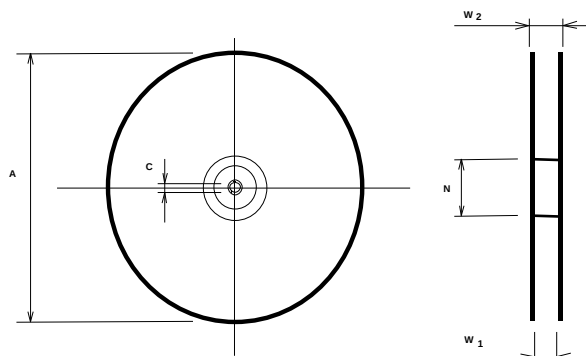
max. pieces of filters per reel:	2000
reel of empty components at start:	min 300 mm
reel of empty components at start including leader:	min 500 mm
trailer	min 300 mm

Tape (all dimensions in mm)

W	: 16 ± 0,3
Po	: 4 ± 0,1
Do	: 1,5 ± 0,1
D1	: 1,5 ± 0,1
E	: 1,75 ± 0,1
F	: 7,5 ± 0,1
G (min)	: 0,6
P2	: 2 ± 0,1
P1	: 12 ± 0,1
D1(min)	: 1,5
Ao	: 7,6 ± 0,1
Bo	: 9,6 ± 0,1

**Reel (all dimensions in mm):**

A	: 330
W1	: 16,4 ± 2
W2 (max)	: 22,4
N (min)	: 60
C	: 12,8 ± 0,1



The minimum bending radius is 45 mm. The mounting surface of the filters faces the bottom side of the embossed carrier tape. Markings on the filters can be read if the upper side of the carrier tape is regarded with the sprocket holes on its right.

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Air reflow temperature conditions

1st and 2nd air reflow profile

Name:	pre-heating periods main-heating periods		peak temperature
Temperature:	150 °C - 170 °C	over 200 °C	255 °C ± 5 °C
Time:	60 sec. - 90 sec.	20 sec. - 25 sec.	

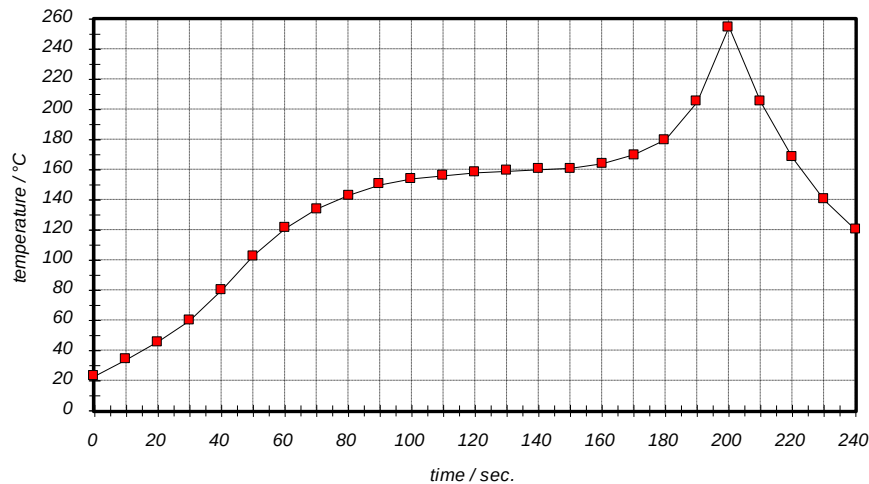
Chip-mount air reflow profile

Table for temperature vs. time during the air reflow process

Tolerance of temperatures: ± 5 °C

time / sec.	temperature / °C	time / sec.	temperature / °C
0	23	140	160
10	34	150	161
20	46	160	164
30	60	170	170
40	80	180	180
50	103	190	205
60	121	195	230
70	134	200	255
80	143	205	230
90	150	210	205
100	154	215	180
110	156	220	165
120	158	230	140
130	159	240	120

Microchip**Filter specification****TFS190D****5/5****History**

Version	Reason of Changes	Name	Date
1.0	generate development specification according to customer requirements	Jaffer	31.07.2001
1.1	Add "frequency inversion temperature" Add "storage temperature" Add "temperature coefficient of frequency" Correct "packing" information	Herrler	01.08.2001
1.2	temperature range adjusted according to customer demands	Steiner	06.08.2001
1.3	Change Input and Output pins	Herrler	16.08.2001
1.4	remove of source/load impedance . remove of phase linearity correct of tape and reel dimensions filter specification	Dr. Sabah	07.09.2001
1.5	terminating impedances added Stability characteristics changed from military standard to common standard	Steiner	28.02.2003

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